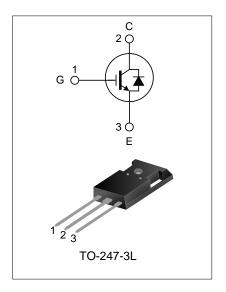
50A, 650V FIELD STOP IGBT

DESCRIPTION

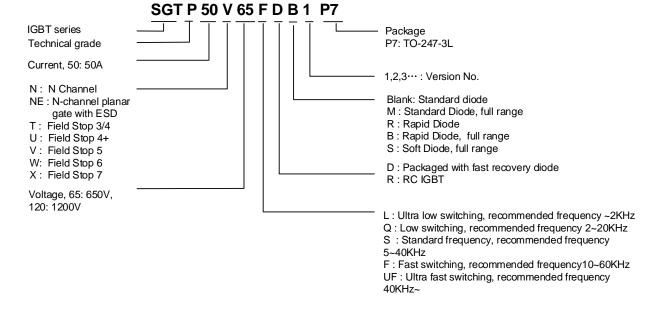
The SGTP50V65FDB1P7 field stop IGBT adopts Silan Field Stop V technology, features low conduction loss and switching loss. This device is applicable to photovoltaic, UPS, SMPS, and PFC fields.

FEATURES

- 50A, 650V, $V_{CE(sat)(typ.)}$ =1.65V@ I_C =50A
- Low conduction loss
- Ultra-fast switching
- High input impedance
- T_{Jmax.}=175°C



NOMENCLATURE



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SGTP50V65FDB1P7	TO-247-3L	P50V65FDB1	Halogen free	Tube

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics		Symbol	Ratings	Unit
Collector to Emitter Voltage		V _{CE}	650	V
Gate to Emitter Volt	tage	V_{GE}	±20	V
Transient Gate to Emitter Voltage (t _p ≤10µs, D<0.010)		V _{GE}	±30	V
Callagtar Current	T _C =25°C		100	Δ.
Collector Current	Tc=100°C	lc	50	Α
Pulsed Collector Cu	Pulsed Collector Current		150	Α
Diodo Current	T _C =25°C		100	Λ
Diode Current	Tc=100°C	- I _F	50	Α
Diode Pulsed Current		I _{FM}	150	Α
Power Dissipation (Tc=25°C)		P _D	273	W
Operating Junction Temperature		TJ	-40∼+175	°C
Storage Temperature Range		T _{stg}	-55∼+150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	Rejc				0.55	°C/W
(IGBT)	KejC				0.55	C/VV
Thermal Resistance, Junction to Case	Rejc	-			0.65	°C/W
(FRD)	Kejc					
Thermal Resistance, Junction to Ambient	D				40	0000
(IGBT)	Reja					°C/W
Soldering Temperature (in line)	T _{sold}	15 ⁺² ₋₀ sec, 1time			260	°C

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ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	BV _{CE}	V _{GE} =0V, I _C =250μA	650			V
C-E Leakage Current	Ices	V _{CE} =650V, V _{GE} =0V			50	μΑ
G-E Leakage Current	Iges	V _{GE} =20V, V _{CE} =0V			±100	nA
G-E Threshold Voltage	V _{GE(th)}	Ic=250μA, Vcε=Vgε	3.2	4.0	5.0	V
Collector to Emitter		Ic=50A, V _{GE} =15V, T _C =25°C		1.65	2.1	V
Saturation Voltage	V _{CE(sat)}	Ic=50A, V _{GE} =15V, T _C =175°C		1.95		V
Input Capacitance	Cies	V _{CE} =30V		3634		
Output Capacitance	Coes	V _{GE} =0V		87		pF
Reverse Transfer Capacitance	Cres	f=1MHz		13		
Turn-On Delay Time	T _{d(on)}	V _{CE} =400V		41		ns
Rise Time	Tr			26		
Turn-Off Delay Time	T _{d(off)}	Ic=50A		170		
Fall Time	Tf	R_g =10 Ω - V_{GE} =15 V - inductive load - T_C =25 $^{\circ}$ C		24		
Turn-On Switching Loss	Eon			0.47		mJ
Turn-Off Switching Loss	E _{off}			0.80		
Total Switching Loss	Est	10=25 C		1.27		
Turn-On Delay Time	T _{d(on)}			37		
Rise Time	Tr	V _{CE} =400V		17		
Turn-Off Delay Time	$T_{d(off)}$	Ic=25A		179		ns
Fall Time	Tf	R_g =10 Ω V_{GE} =15 V inductive load T_{C} =25 $^{\circ}$ C		24		
Turn-On Switching Loss	Eon			0.17		
Turn-Off Switching Loss	E _{off}			0.39		mJ
Total Switching Loss	E _{st}			0.56		
Total Gate Charge	Qg			129		
Gate to Emitter Charge	Qge	V _{CE} =520V, I _C =50A, V _{GE} =15V		25		nC
Gate to Collector Charge	Qgc			35		

ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _{FM}	I _F =50A, T _C =25°C	1	1.45	1.9	- v
Diode Forward Voltage		I _F =50A, T _C =175°C		1.35		
Diode Reverse Recovery Time	Trr	1 500 dl /dt 2000///-		132		ns
Diode Reverse Recovery Charge	Qrr	les=50A, dles/dt=200A/ μ s, V _R =50V, T _C =25°C		0.35		μC
Diode Reverse Recovery Current	Irm			6.0		Α

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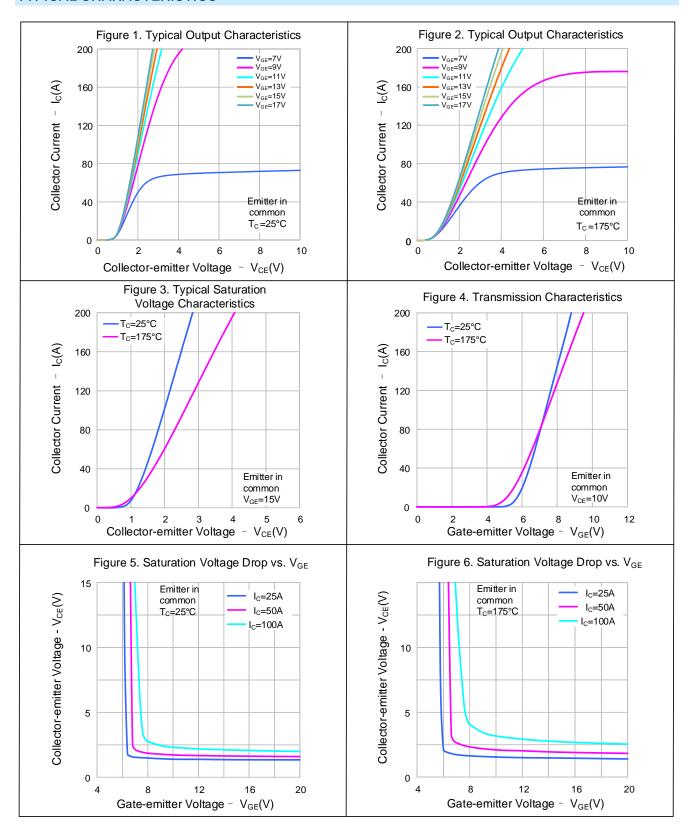
ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, Tc=175°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-On Delay Time	T _{d(on)}			40		9
Rise Time	Tr	V _{CE} =400V		28		
Turn-Off Delay Time	$T_{d(off)}$	Ic=50A		210		ns
Fall Time	T _f	R _g =10Ω		29		
Turn-On Switching Loss	Eon	V _{GE} =15V		0.59		mJ
Turn-Off Switching Loss	E _{off}	inductive load T _C =175°C		1.08		
Total Switching Loss	Est			1.67		
Turn-On Delay Time	T _{d(on)}	$\begin{array}{c} V_{\text{CE}}\text{=}400V \\ \text{Ic}\text{=}25A \\ \text{R}_{\text{g}}\text{=}10\Omega \\ \text{V}_{\text{GE}}\text{=}15V \\ \text{inductive load} \\ \text{-}T_{\text{c}}\text{=}175^{\circ}\text{C} \\ \end{array}$		36		ns
Rise Time	Tr			18		
Turn-Off Delay Time	$T_{d(off)}$			234		
Fall Time	Tf			25		
Turn-On Switching Loss	Eon			0.20		
Turn-Off Switching Loss	E _{off}			0.52		mJ
Total Switching Loss	E _{st}			0.72		

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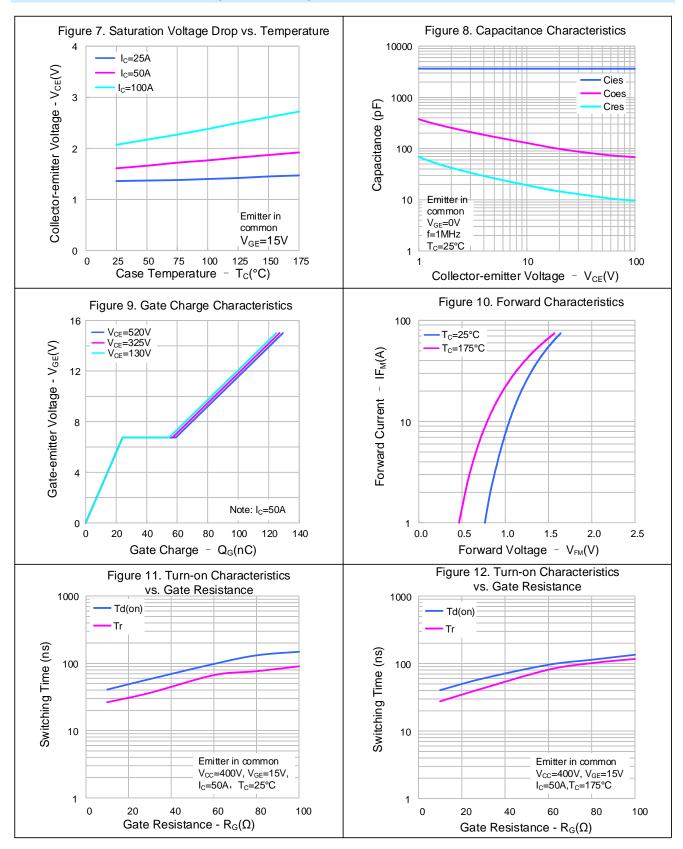
TYPICAL CHARACTERISTICS



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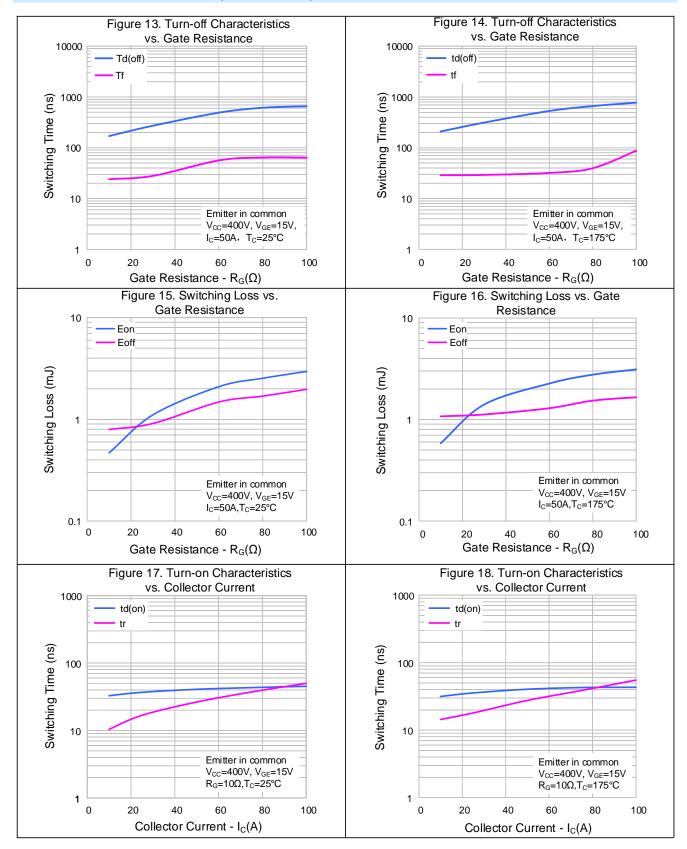
TYPICAL CHARACTERISTICS (CONTINUED)



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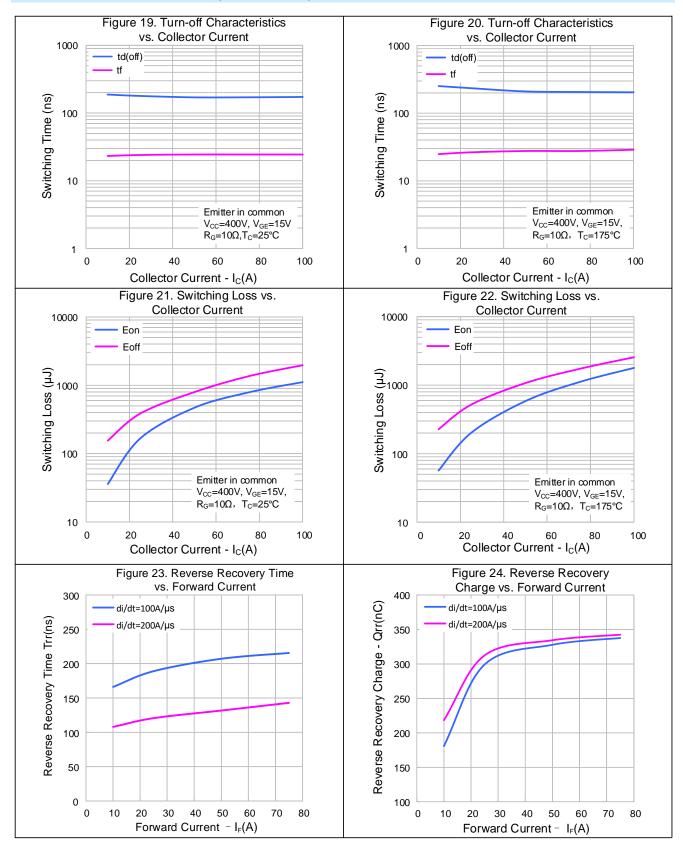
TYPICAL CHARACTERISTICS (CONTINUED)



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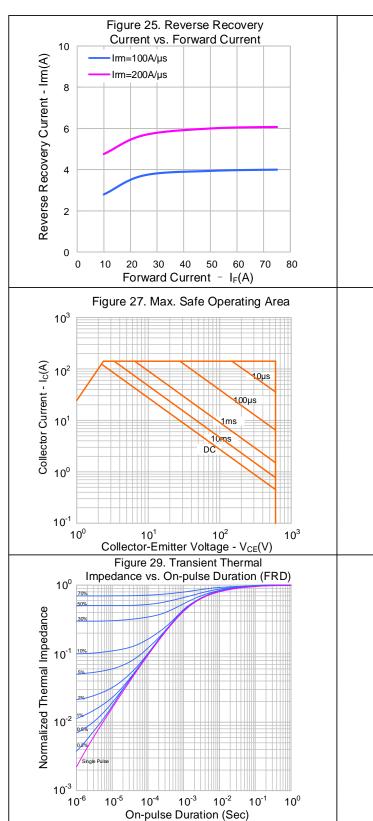
TYPICAL CHARACTERISTICS (CONTINUED)

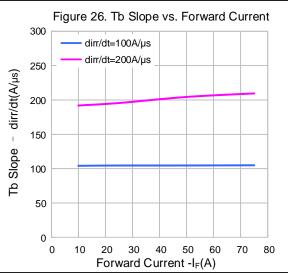


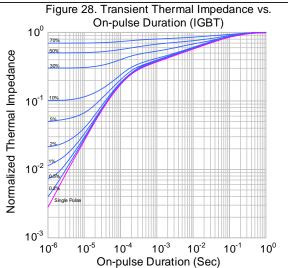
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TYPICAL CHARACTERISTICS (CONTINUED)



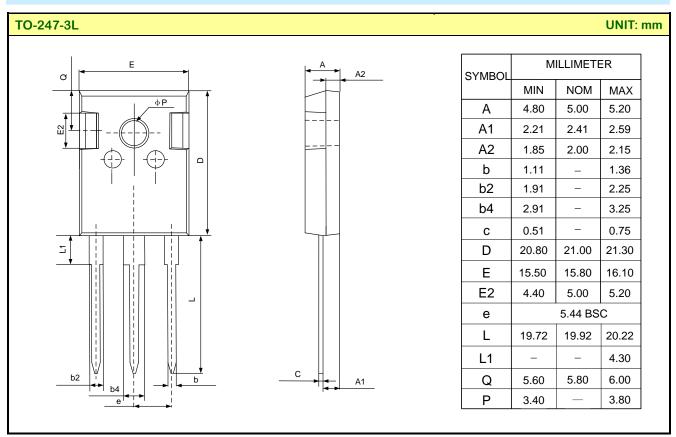




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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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- 1. Silan reserves the right to make changes of this instruction without notice.
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First release

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